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Vishay Semiconductors

Thyristor High Voltage Surface Mount Phase Control SCR, 10 A



2, 4 Anode
O
*
1 3 Cathode Gate

PRODUCT SUMMARY							
Package	TO-263AB (D ² PAK)						
Diode variation	Single SCR						
I _{T(AV)}	6.5 A						
V _{DRM} /V _{RRM}	800 V						
V_{TM}	< 1.15 V						
I _{GT}	15 mA						
TJ	-40 to +125 °C						

FEATURES

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Designed and qualified according JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- · Input rectification (soft start)
- Vishay input diodes, switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-10TTS08SPbF high voltage series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

OUTPUT CURRENT IN TYPICAL APPLICATIONS									
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS									
NEMA FR-4 or G-10 glass fabric-based epoxy with 4 oz. (140 μm) copper	2.5	3.5							
Aluminum IMS, R _{thCA} = 15 °C/W	6.3	9.5	A						
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	14.0	18.5							

Note

• $T_A = 55$ °C, $T_J = 125$ °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS									
PARAMETER	TEST CONDITIONS	UNITS							
I _{T(AV)}	Sinusoidal waveform	6.5	A						
I _{RMS}		10	^						
V _{RRM} /V _{DRM}		800	V						
I _{TSM}		110	A						
V _T	6.5 A, T _J = 25 °C	1.15	V						
dV/dt		150	V/µs						
dl/dt		100	A/µs						
TJ	Range	-40 to +125	°C						

VOLTAGE RATINGS									
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} AT 125 °C mA						
VS-10TTS08SPbF	800	800	1.0						



PARAMETER	SYMBOL	TEST COM	NDITIONS	VALUES	UNITS
Maximum average on-state current	I _{T(AV)}	6.5		6.5	
Maximum RMS on-state current	I _{T(RMS)}	$T_C = 112 ^{\circ}\text{C}, 180^{\circ} \text{conduc}$	tion nair sine wave	10	•
Maximum peak, one-cycle,		10 ms sine pulse, rated V _F	RRM applied, T _J = 125 °C	95	А
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no volta	ge reapplied, T _J = 125 °C	110	
Maximum 12t for funing	I ² t	10 ms sine pulse, rated V _F	RRM applied, T _J = 125 °C	45	A ² s
Maximum I ² t for fusing	1-1	10 ms sine pulse, no volta	ge reapplied, T _J = 125 °C	64	A-S
Maximum I ² √t for fusing	I ² √t	t = 0.1 ms to 10 ms, no vol	640	A²√s	
Maximum on-state voltage drop	V_{TM}	6.5 A, T _J = 25 °C	1.15	V	
On-state slope resistance	r _t	T 105 %C	17.3	mΩ	
Threshold voltage	V _{T(TO)}	T _J = 125 °C		0.85	V
Maximum various and direct lockers comment	1 //	T _J = 25 °C	V Detect V A/	0.05	
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	T _J = 125 °C	$V_R = Rated V_{RRM}/V_{DRM}$	1.0	
Typical holding current	I _H	Anode supply = 6 V, resist $T_J = 25 ^{\circ}\text{C}$	30	mA	
Maximum latching current	ΙL	Anode supply = 6 V, resist	50		
Maximum rate of rise of off-state voltage	dV/dt	$T_J = T_J \text{ max., linear to } 80 \text{ %, } V_{DRM} = R_g - k = Open$			V/µs
Maximum rate of rise of turned-on current	dl/dt			100	A/µs

TRIGGERING								
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS				
Maximum peak gate power	P_{GM}		8.0	W				
Maximum average gate power	P _{G(AV)}		2.0	VV				
Maximum peak positive gate current	+I _{GM}		1.5	Α				
Maximum peak negative gate voltage	-V _{GM}		10	V				
Maximum required DC gate current to trigger		Anode supply = 6 V, resistive load, T _J = - 65 °C	20	mA				
	I _{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	15					
		Anode supply = 6 V, resistive load, T _J = 125 °C	10					
		Anode supply = 6 V, resistive load, T _J = - 65 °C	1.2					
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	1	V				
voltage to trigger		Anode supply = 6 V, resistive load, T _J = 125 °C	0.7	V				
Maximum DC gate voltage not to trigger	V_{GD}	T 105 °C V Detect value	0.2					
Maximum DC gate current not to trigger	I _{GD}	T _J = 125 °C, V _{DRM} = Rated value	0.1	mA				

SWITCHING									
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS					
Typical turn-on time	t _{gt}	T _J = 25 °C	0.8						
Typical reverse recovery time	t _{rr}	T = 105 °C	3	μs					
Typical turn-off time	t _q	T _J = 125 °C	100						

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	ARAMETER SYMBOL TEST CONDITIONS							
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +125	°C				
Soldering temperature	T _S	For 10 s (1.6 mm from case)	260					
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	1.5	°C/W				
Typical thermal resistance, junction to ambient (PCB mount)	R _{thJA} ⁽¹⁾		40	C/VV				
Approximate weight			2	g				
Approximate weight			0.07	OZ.				
Marking device		Case style D ² PAK (SMD-220)	10TTS	08S				

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

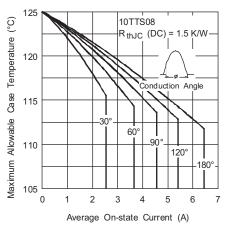


Fig. 1 - Current Rating Characteristics

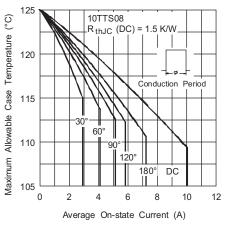


Fig. 2 - Current Rating Characteristics

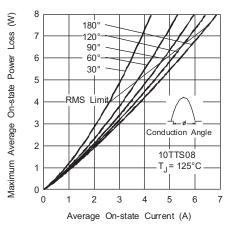


Fig. 3 - On-State Power Loss Characteristics

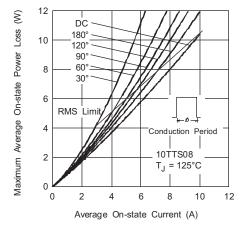


Fig. 4 - On-State Power Loss Characteristics

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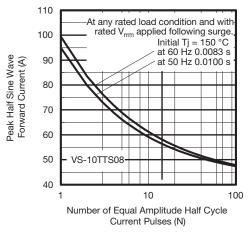


Fig. 5 - Maximum Non-Repetitive Surge Current

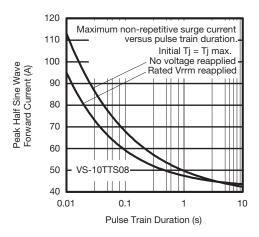


Fig. 6 - Maximum Non-Repetitive Surge Current

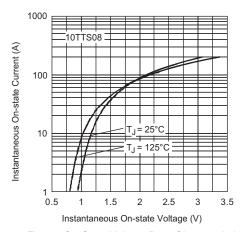


Fig. 7 - On-State Voltage Drop Characteristics

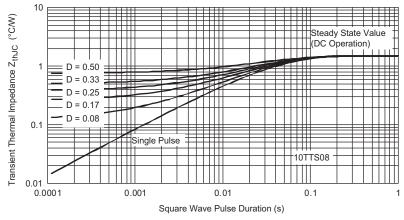
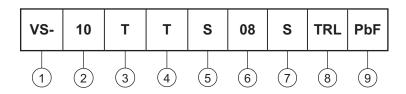


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- Current rating, RMS value
- 3 Circuit configuration:

T = single thyristor

- 4 Package:
 - T = TO-220AC
- 5 Type of silicon:
 - S = converter grade
- 6 Voltage code x 100 = V_{RRM}
- 7 S = TO-220 D²PAK (SMD-220) version
- 8 Tape and reel option:
 - TRL = tape and reel (left oriented)
 - TRR = tape and reel (right oriented)
- 9 PbF = lead (Pb)-free

ORDERING INFORMATION (Example)									
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION						
VS-10TTS08SPbF	50	1000	Antistatic plastic tubes						
VS-10TTS08STRRPbF	800	800	13" diameter reel						
VS-10TTS08STRLPbF	800	800	13" diameter reel						

LINKS TO RELATED DOCUMENTS						
Dimensions <u>www.vishay.com/doc?95046</u>						
Part marking information	www.vishay.com/doc?95054					
Packaging information	www.vishay.com/doc?95032					



D²PAK

DIMENSIONS in millimeters and inches



SYMBOL	MILLIM	ETERS	INC	HES	NOTES	SYMBOL	MILLIM	ETERS	INC	HES	NOTES	
STIVIBUL	MIN.	MAX.	MIN.	MAX.		STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190			D1	6.86	8.00	0.270	0.315	3
A1	0.00	0.254	0.000	0.010			Е	9.65	10.67	0.380	0.420	2, 3
b	0.51	0.99	0.020	0.039			E1	7.90	8.80	0.311	0.346	3
b1	0.51	0.89	0.020	0.035	4		е	2.54	BSC	0.100) BSC	
b2	1.14	1.78	0.045	0.070			Н	14.61	15.88	0.575	0.625	
b3	1.14	1.73	0.045	0.068	4		L	1.78	2.79	0.070	0.110	
С	0.38	0.74	0.015	0.029			L1	-	1.65	-	0.066	3
c1	0.38	0.58	0.015	0.023	4		L2	1.27	1.78	0.050	0.070	
c2	1.14	1.65	0.045	0.065			L3	0.25	BSC	0.010	BSC	
D	8.51	9.65	0.335	0.380	2		L4	4.78	5.28	0.188	0.208	

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB

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